This amendment is being filed in response to the Office Action mailed May 5,

2005. Currently pending in the application are claims 13, 14, 16, 23, 26, and 27. In the

Office Action, claims 23, 26 and 27 were rejected and claims 13, 14, and 16 were

objected to. Applicants note with appreciation the indication of allowable subject matter.

In this amendment, applicants have amended claims 13, 14, and 16 to remove

rejections and believe that these claims are now in condition for allowance.

Claim 26 has now been incorporated into claim 23. The Examiner had rejected

claim 23 on the LeBlanc reference and on double patenting. Applicants are enclosing

herein a terminal disclaimer to remove the double patenting rejection.

In addition, applicants believe that the feature of reduced voids in the space

between filaments should not be subject to the inherency rejection that the Examiner

raised in the Office Action.

The abstract of the LeBlanc reference does not recognize that voids are a

problem which they are in the use of epoxy circuit boards that are reinforced with

fiberglass fibers. In fact, it is not mentioned that voids occur or don't occur in the

structures and resins used by LeBlanc. However, voids did and do occur in epoxy

structure not treated according to the present invention. Applicants have discovered

that such a reduction does occur in its epoxy based articles and the teachings of

LeBlanc do not make such a treatment "inherent." Applicants' claim 23 treats the use of

the latent catalyst inhibitor as an improvement perhaps in the nature of a new use not

Page 4 of 5

GREENVILLE 213434v1

Appl. No. 10/625,261 Amdt. dated August 4, 2005

Reply to Office Action of May 5, 2005

recognized or known heretofore. Thus, applicants' claim 23 is directed to a novel and non-obvious invention.

Accordingly, applicants respectfully reconsideration of their application and a favorable action is respectfully requested.

Respectfully submitted,

William D. Lee, Jr.

Registration No.22,660

McNair Law Firm, P.A.

P.O. Box 10827

Greenville, SC 29603-0827 Telephone: (864) 232-4261

Attorney for the Applicants